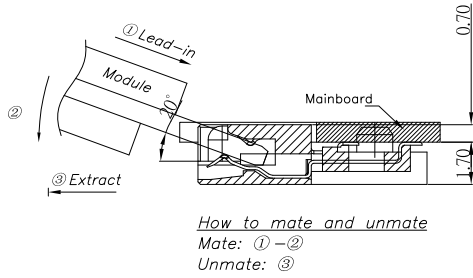
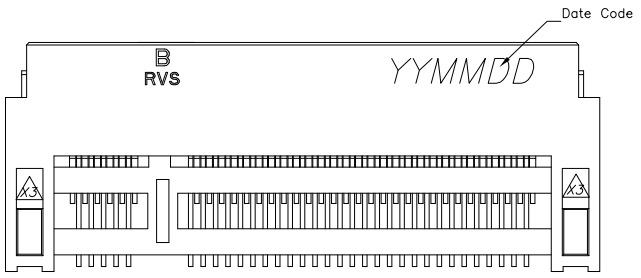
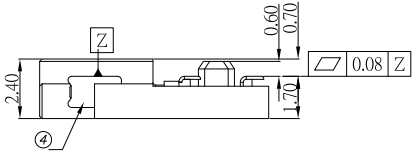
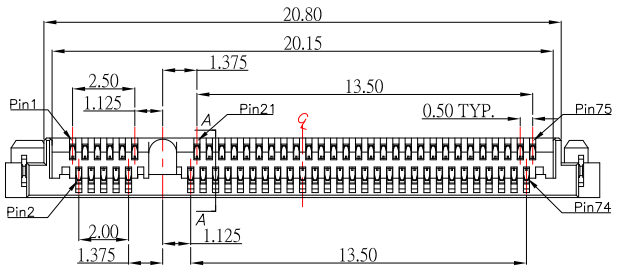
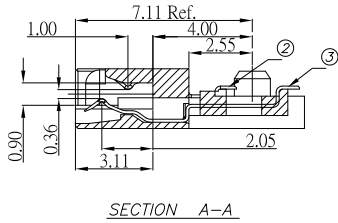
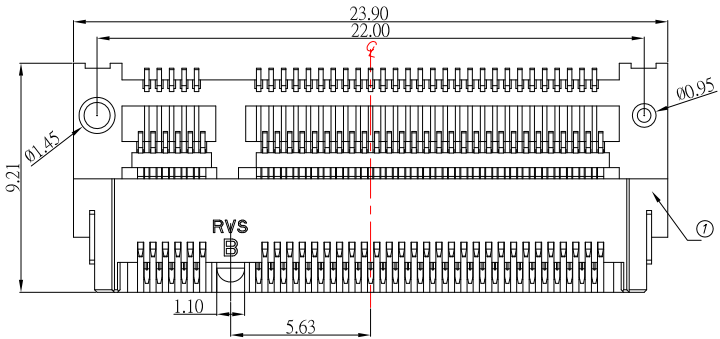




NGF-18MB-xx-S273

鍍層厚度 :	COLOR :
Blank : 1u"	Black: B
2 : 15u"	White : W
3 : 30u"	

- 1.SPECIFICATION:
- 1.1 Current Rate: 0.5 A
 - 1.2 Voltage Rate: 50V AC
 - 1.3 Insulator Resistance: 500 M Ω Min
 - 1.4 Dielectric Strength: 300V AC
 - 1.5 Contact Resistance: 20m Ω Max
 - 1.6 Mating Force: 20N Max
 - 1.7 Unmating Force: 20N Max
- 2.MATERIAL:
- 2.1 Housing: LCP,UL94V-0
 - 2.2 Contact: Phosphor Bronze
 - 2.3 Leg: Brass
- 3.Finish:
- 3.1 Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
 - 3.2 Leg: Tin Plated on Solder Balls
Nickel under plated overall



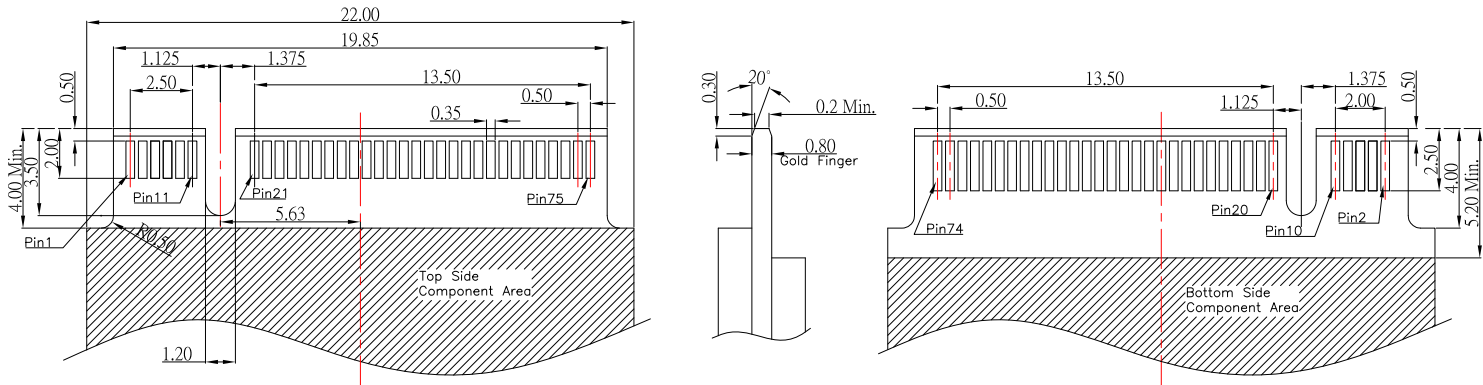


建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

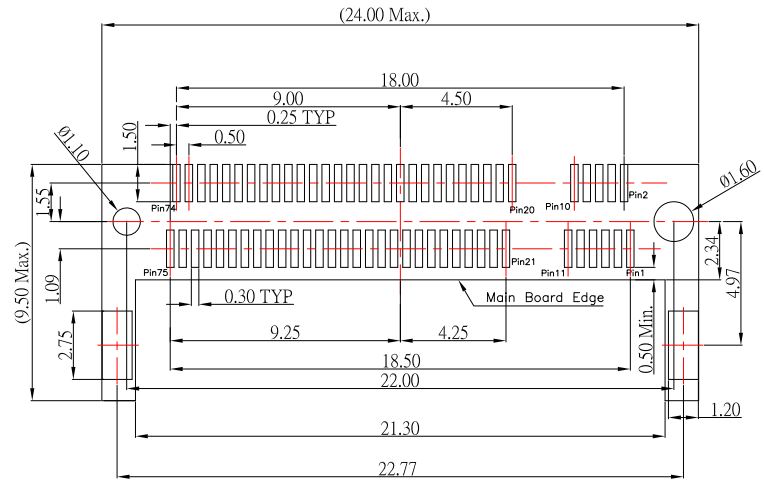
TOLERANCE UNLESS OTHERWISE STATED :	Up to 5 ±0.2	3RD. ANGEL'S	UNITS	MM
	Above 5 ~ 15 ±0.3			
	Above 15 ~ 30 ±0.4			
	Above 30 ~ 50 ±0.5			
	Angle ±0.3°			

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	11/29/16			
CHECKED BY:	DATE	FINISH	MODLE	NGFF SOCKET
Jacky Chen	11/29/16			
APPROVED BY:	DATE	SCALE	DWG NO.	NGF-18MB-xx-S273
Tony Kao	11/29/16	1 : 1		
		SHEET NO.	PART NO.	NGF-18MB-xx-S273
				SIZE A4
				VER R1

1	更新料號	Jack	112916
ITEM NO.	DESCRIPTION	DRAWN	DATE



Recommended Mould Finger Layout



Recommended PCB Layout(Top View)

				CONTACT 建倚科技股份有限公司 CONTACT TECHNOLOGY CORP. TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2 Above 5 ~ 15 ±0.3 Above 15 ~ 30 ±0.4 Above 30 ~ 50 ±0.5 Angle ±0.3° 3RD. ANGEL'S UNITS MM				DRAWN BY: DATE		MAT'L		TITLE		CONNECTOR							
								CHECKED BY: DATE		FINISH		MODLE		NGFF SOCKET							
								APPROVED BY: DATE		SCALE		1 : 1		DWG NO.		NGF-18MB-xx-S273		SIZE			
1更新料號Jack112916																					
ITEM NO. DESCRIPTION				DRAWN DATE				Tony Kao11/29/16		SHEET NO. 2 of 2		PART NO.		NGF-18MB-xx-S273		VER R1					
A				B		C		D		E		F		G		H		I		J	